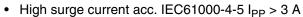


# Low Capacitance, Single-Line ESD-Protection Diode

#### **Features**

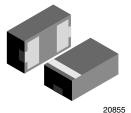
- Ultra compact LLP1006-2L package
- Low package height < 0.4 mm
- 1-line ESD-protection
- Low leakage current < 0.1 μA</li>
- Low load capacitance C<sub>D</sub> = 0.9 pF
- ESD-protection to IEC 61000-4-2
  ± 15 kV contact discharge
  ± 15 kV air discharge



- Soldering can be checked by standard vision inspection. No X-ray necessary
- Lead (Pb)-free component
- Pin plating NiPdAu (e4) no whisker growth
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC









## Marking (example only)



Bar = Cathode marking X = Date code

Y = Type code (see table below)

### **Ordering Information**

Device name Ordering code		Taped units per reel (8 mm tape on 7" reel)	Minimum order quantity		
VBUS051BD-HD1	VBUS051BD-HD1-GS08	8000	8000		

#### **Package Data**

Device name	Package name	Type code	Weight	Molding compound flammability rating	Moisture sensitivity level	Soldering conditions
VBUS051BD-HD1	LLP1006-2L	Α	0.72 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

### **Absolute Maximum Ratings**

	3				
Parameter	Test conditions	Symbol	Value	Unit	
Peak pulse current	Acc. IEC 61000-4-5; $t_P = 8/20 \mu s$ ; single shot	I <sub>PPM</sub>	3	Α	
Peak pulse power	Acc. IEC 61000-4-5; $t_P = 8/20 \mu s$ ; single shot	P <sub>PP</sub>	45	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	± 15	kV	
L3D illillulilly	Air discharge acc. IEC 61000-4-2; 10 pulses	V <sub>ESD</sub>	± 15	kV	
Operating temperature	Junction temperature	$T_J$	- 40 to + 125	°C	
Storage temperature		T <sub>STG</sub>	- 40 to + 150	°C	

<sup>\*</sup> Please see document "Vishay Green and Halogen-Free Definitions (5-2008)" http://www.vishay.com/doc?99902

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#### **Electrical Characteristics**

Ratings at 25 °C, ambient temperature unless otherwise specified

#### VBUS051BD-HD1

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	Number of line which can be protected	N lines			1	lines
Reverse stand-off voltage	at $I_R = 0.1 \mu A$ ; pin 2 to pin 1	V <sub>RWM</sub>	5			V
Reverse current	at $V_R = V_{RWM} = 5 V$ ; pin 2 to pin 1	I <sub>R</sub>		< 0.01	0.1	μΑ
Reverse breakdown voltage	at I <sub>R</sub> = 1 mA pin 2 to pin 1	V <sub>BR</sub>	6.9	7.9	8.7	V
Reverse clamping voltage	at I <sub>PP</sub> = 3 A; acc. IEC 61000-4-5; pin 2 to pin 1	V <sub>C</sub>			16	V
Forward clamping voltage	at I <sub>F</sub> = 3 A; acc. IEC 61000-4-5; pin 1 to pin 2	V <sub>F</sub>		1.9	2.5	V
Capacitance	at $V_R = 0$ V; $f = 1$ MHz; pin 2 to pin 1	C <sub>D</sub>		0.9	1.3	pF

### **Application Note**

The **VBUS051BD-HD1** is an ESD-protection device with the characteristic of a Z-diode with a high ESD-immunity and a very low capacitance which makes it usable for high frequency applications like USB2.0 or HDMI

With the **VBUS051BD-HD1** one high speed data line can be protected against transient voltage signals like ESD (Electro Static Discharge). Connected to the data line (pin 2) and to ground (pin 1) negative transients will be clamped close below the ground level while positive transients will be clamped close above the 5 V working range. The clamping behaviour of the **VBUS051BD-HD1** is bidirectional but asymmetrical (**BiAs**) and so it offers the best protection for applications running up to 5 V.

## **Typical Characteristics**

T<sub>amb</sub> = 25 °C, unless otherwise specified

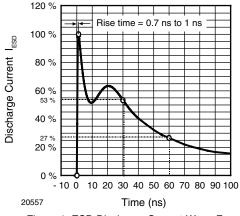


Figure 1. ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330  $\Omega$ /150 pF)

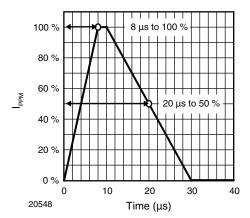


Figure 2. 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5



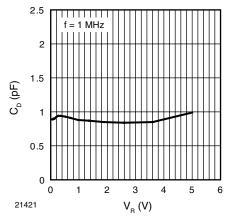


Figure 3. Typical Capacitance  $C_{\mathsf{D}}$  vs. Reverse Voltage  $V_{\mathsf{R}}$ 

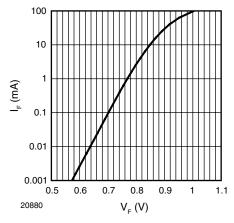


Figure 4. Typical Forward Current I<sub>F</sub> vs. Forward Voltage V<sub>F</sub>

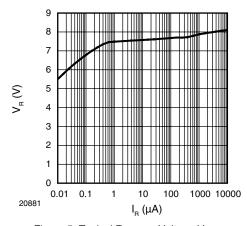


Figure 5. Typical Reverse Voltage  $V_R$  vs. Reverse Current  $I_R$ 

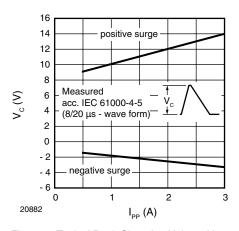


Figure 6. Typical Peak Clamping Voltage  $V_{\rm C}$  vs. Peak Pulse Current  $I_{\rm PP}$ 

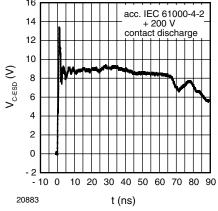


Figure 7. Typical Clamping Performance at + 200 V Contact Discharge (acc. IEC 61000-4-2)

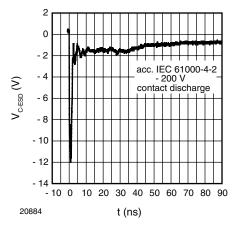


Figure 8. Typical Clamping Performance at - 200 V Contact Discharge (acc. IEC 61000-4-2)



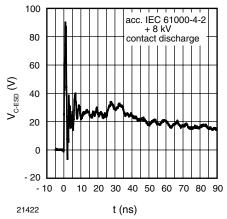


Figure 9. Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

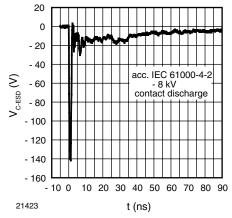


Figure 10. Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

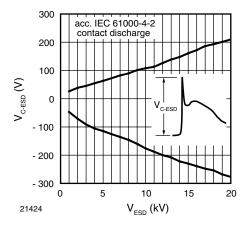
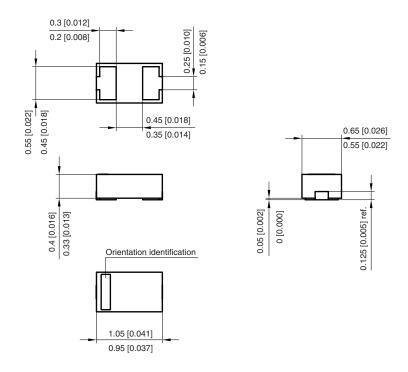
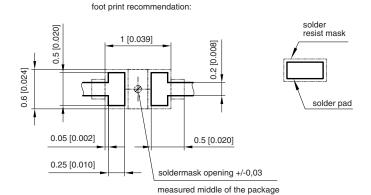


Figure 11. Typical Peak. Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)



## Package Dimensions in millimeters (inches): LLP1006-2L





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## VBUS051BD-HD1

#### **Vishay Semiconductors**



#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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